





SURFACE MOUNT SCHOTTKY BARRIER DIODE

Features

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- Negligible Reverse Recovery Time
- Low Reverse Capacitance
- Ultra-Small Surface Mount Package
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability



Top View

Mechanical Data

- Case: SOD523
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 ©3
- · Polarity: Cathode Band
- Weight: 0.002 grams (approximate)



Ordering Information (Note 4)

| Device | Packaging | Shipping |
|----------------------|-----------|--------------------|
| SDM20U40-7 (Note 5) | SOD523 | 3,000/Tape & Reel |
| SDM20U40-13 (Note 6) | SOD523 | 10,000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html
- 5. Dispensed in every other cavity of the tape.
- 6. Dispensed in every cavity of the tape.

Marking Information



S4 = Product Type Marking Code



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|--|--|-------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _R | 40 | V |
| RMS Reverse Voltage | $V_{R(RMS)}$ | 28 | V |
| Forward Continuous Current (Note 7) | I _{FM} | 250 | mA |
| Non-Repetitive Peak Forward Surge Current @ | t ≤ 1.0s I _{FSM} | 1.0 | Α |

Thermal Characteristics

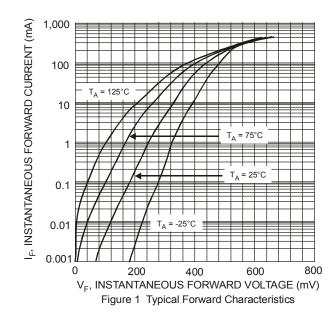
| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Power Dissipation (Note 7) | P_{D} | 150 | mW |
| Thermal Resistance, Junction to Ambient Air (Note 7) | $R_{\theta JA}$ | 667 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -65 to +125 | °C |

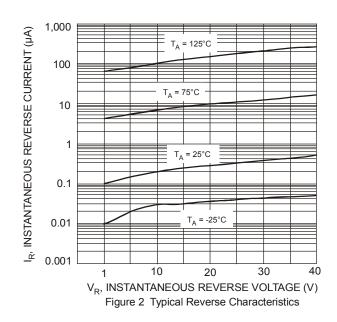
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Conditions |
|------------------------------------|-----------------|-----|-----|----------------------|----------|---|
| Reverse Breakdown Voltage (Note 8) | $V_{(BR)R}$ | 40 | _ | _ | V | $I_R = 10\mu A$ |
| Forward Voltage Drop | V _F | _ | _ | 0.35 0.37 0.60 | V | I _F = 10mA I _F = 20mA I _F = 200mA |
| Peak Reverse Current (Note 8) | I _R | _ | _ | 5 1 | μA μA | V _R = 30V V _R = 10V |
| Total Capacitance | C _T | _ | 50 | _ | pF | $V_R = 0V, f = 1.0MHz$ |
| Reverse Recovery Time | t _{rr} | _ | 10 | _ | ns | $I_F = I_R = 200 \text{mA},$ $I_{rr} = 0.1 \text{ x } I_R, R_L = 100 \Omega$ |

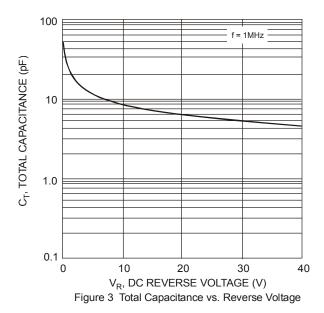
Notes:

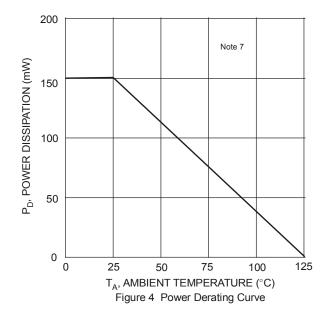
- 7. Device mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
- 8. Short duration pulse test used so as to minimize self-heating effect.





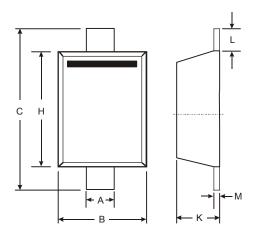






Package Outline Dimensions

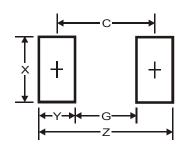
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



| SOD523 | | | | |
|----------------------|------|------|--|--|
| Dim | Min | Max | | |
| Α | 0.25 | 0.35 | | |
| В | 0.70 | 0.90 | | |
| С | 1.50 | 1.70 | | |
| Н | 1.10 | 1.30 | | |
| K | 0.55 | 0.65 | | |
| L | 0.10 | 0.30 | | |
| M | 0.10 | 0.12 | | |
| All Dimensions in mm | | | | |

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.3 |
| G | 1.1 |
| Х | 0.8 |
| Y | 0.6 |
| С | 1.7 |



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